Revisions

Rev. 0.0 : Development version

Rev. A.0 : Initial Release
- R14 changed to 47k, C45 changed to 2200pf
- U2 pin 2 disconnected from 3.3V and connected to 1.8V
- Add net SCL_IFP to IIC0_SCL
- Add net SDA_IFP to IIC0_SDA

Rev. B.0 : Do not install unused connectors, etc.
- VR1, J8, J13,

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